



# High Speed CMOS TTL Input – 74HCT86

Quadruple 2-Input Exclusive OR Gate IC in bare die form

Rev 1.1  
31/07/21

## Description

The 74HCT86 XOR gate is fabricated using a 2.5µm 5V CMOS process with the same high speed performance of LSTTL combined with CMOS low power consumption. The device contains four independent gates and performs the Boolean function  $Y = A \oplus B = \bar{A}B + A\bar{B}$  in positive logic. All inputs are protected against ESD and excess voltage transients. Device inputs directly accept LSTTL or CMOS.

## Features:

- Output Drive Capability: 10 LSTTL Loads
- Low Input Current: 1µA
- Outputs directly interface CMOS, NMOS and TTL
- Operating Voltage Range: 4.5V to 5.5V
- TTL / CMOS compatible Input Levels
- Function compatible with 74LS86.

## Ordering Information

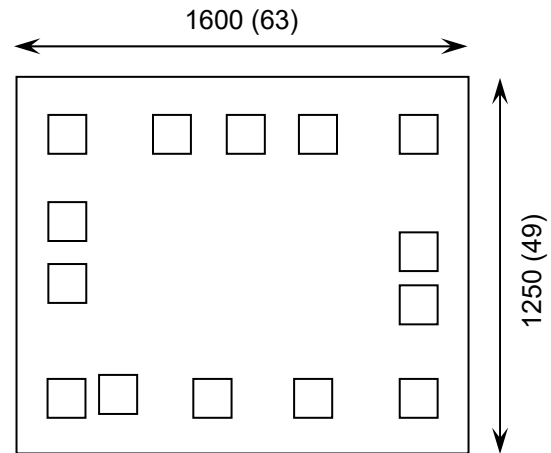
The following part suffixes apply:

- No suffix - MIL-STD-883 /2010B Visual Inspection

For High Reliability versions of this product please see

[54HCT86](#)

## Die Dimensions in µm (mils)



## Supply Formats:

- Default – Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape – On request
- Unsawn Wafer – On request
- Die Thickness <=> 350µm(14 Mils) – On request
- Assembled into Ceramic Package – On request

## Mechanical Specification

Die Size (Unsawn)	1600 x 1250 63 x 49	µm mils
Minimum Bond Pad Size	120 x 120 4.72 x 4.72	µm mils
Die Thickness	350 (±20) 13.78 (±0.79)	µm mils
Top Metal Composition	Al 1%Si 1.1µm	
Back Metal Composition	N/A – Bare Si	

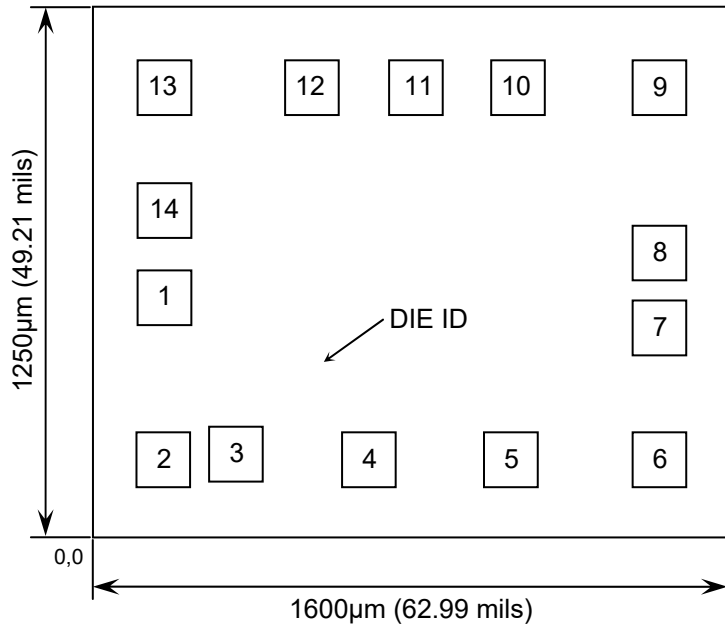




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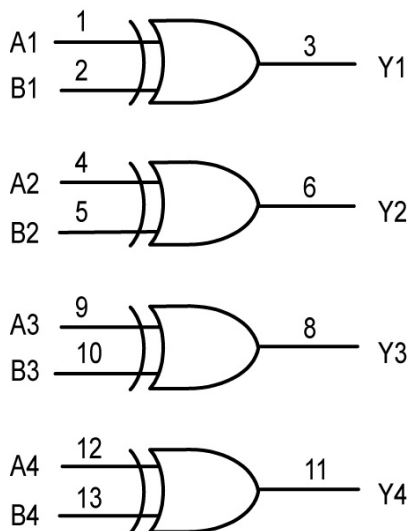
## Pad Layout and Functions



PAD	FUNCTION	COORDINATES (mm)	
		X	Y
1	A1	0.125	0.500
2	B1	0.125	0.125
3	Y1	0.305	0.130
4	A2	0.635	0.125
5	B2	0.995	0.125
6	Y2	1.355	0.125
7	GND	1.355	0.435
8	Y3	1.355	0.610
9	A3	1.355	1.000
10	B3	0.995	1.000
11	Y4	0.745	1.000
12	A4	0.485	1.000
13	B4	0.125	1.000
14	V <sub>CC</sub>	0.125	0.710

CONNECT CHIP BACK TO V<sub>CC</sub> OR FLOAT

## Logic Diagram



$$Y = A \oplus B$$

$$= \bar{A}B + A\bar{B}$$

## Function Table

INPUTS		OUTPUT
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

H = High level (steady state)  
L = Low level (steady state)





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## Absolute Maximum Ratings<sup>1</sup>

PARAMETER	SYMBOL	VALUE	UNIT
DC Supply Voltage (Referenced to GND)	$V_{CC}$	-0.5 to +7.0	V
DC Input Voltage (Referenced to GND)	$V_{IN}$	-0.5 to $V_{CC} + 0.5$	V
DC Output Voltage (Referenced to GND)	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
DC Input Current	$I_{IN}$	$\pm 20$	mA
DC Output Current, per pad	$I_{OUT}$	$\pm 25$	mA
DC Supply Current, $V_{CC}$ or GND, per pad	$I_{CC}$	$\pm 50$	mA
Power Dissipation in Still Air <sup>2</sup>	$P_D$	750	mW
Storage Temperature Range	$T_{STG}$	-65 to 150	°C

1. Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability. 2. Measured in plastic DIP package, results in die form are dependent on die attach and assembly method.

## Recommended Operating Conditions<sup>3</sup> (Voltages referenced to GND)

PARAMETER	SYMBOL	MIN	MAX	UNITS
Supply Voltage	$V_{CC}$	4.5	5.5	V
DC Input or Output Voltage	$V_{IN}, V_{OUT}$	0	$V_{CC}$	V
Operating Temperature Range	$T_J$	0	+85	°C
Input Rise or Fall Times	$t_r, t_f$	-	500	ns

3. This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{IN}$  and  $V_{OUT}$  should be constrained to the range  $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

## DC Electrical Characteristics (Voltages Referenced to GND)

PARAMETER	SYMBOL	$V_{CC}$	CONDITIONS	LIMITS			UNITS
				25°C	85°C	FULL RANGE <sup>4</sup>	
Minimum High-Level Input Voltage	$V_{IH}$	4.5V	$V_{OUT} = 0.1V \text{ or } V_{CC} - 1$ $ I_{OUT}  \leq 20\mu A$	2.0	2.0	2.0	V
		5.5V		2.0	2.0	2.0	
Maximum Low-Level Input Voltage	$V_{IL}$	4.5V	$V_{OUT} = 0.1V \text{ or } V_{CC} - 1$ $ I_{OUT}  \leq 20\mu A$	0.8	0.8	0.8	V
		5.5V		0.8	0.8	0.8	
Minimum High-Level Output Voltage	$V_{OH}$	4.5V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $ I_{OUT}  \leq 20\mu A$	4.4	4.4	4.4	V
		5.5V		5.4	5.4	5.4	
		4.5V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $ I_{OUT}  \leq 4.0mA$	3.98	3.84	3.84	
Maximum Low-Level Output Voltage	$V_{OL}$	4.5V	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT}  \leq 20\mu A$	0.1	0.1	0.1	V
		5.5V		0.1	0.1	0.1	
		4.5V	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT}  \leq 4.0mA$	0.26	0.33	0.33	





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## DC Electrical Characteristics Continued (Voltages Referenced to GND)

PARAMETER	SYMBOL	V <sub>CC</sub>	CONDITIONS	LIMITS			UNITS
				25°C	85°C	FULL RANGE <sup>4</sup>	
Maximum Input Leakage Current	I <sub>IN</sub>	5.5V	V <sub>IN</sub> = V <sub>CC</sub> or GND	±0.1	±1.0	±1.0	µA
Maximum Quiescent Supply Leakage Current <sup>3</sup>	I <sub>CC</sub>	5.5V	V <sub>IN</sub> = V <sub>CC</sub> or GND I <sub>OUT</sub> = 0µA	2	20	20	µA
Additional Quiescent Supply Current <sup>5</sup>	ΔI <sub>CC</sub>	5.5V	V <sub>IN</sub> = 2.4V, Any One Input. V <sub>IN</sub> = V <sub>CC</sub> or GND, Other Inputs I <sub>OUT</sub> = 0µA	≥ 0°C	25°C to 125°C		mA
				2.9	2.4		

4. 0°C ≤ T<sub>J</sub> ≤ +85°C.

5. Total Supply Current = I<sub>CC</sub> + ΣΔI<sub>CC</sub>

## AC Electrical Characteristics<sup>6</sup>

PARAMETER	SYMBOL	V <sub>CC</sub>	CONDITIONS	LIMITS			UNITS
				25°C	85°C	FULL RANGE <sup>4</sup>	
Maximum Propagation Delay, Input A to Input Y (Figure 1,2)	t <sub>PLH</sub>	5V ±10%	C <sub>L</sub> = 50pF, t <sub>r</sub> = t <sub>f</sub> = 6ns	24	30	36	ns
Maximum Propagation Delay, Input A to Input Y (Figure 1,2)	t <sub>PHL</sub>	5V ±10%	C <sub>L</sub> = 50pF, t <sub>r</sub> = t <sub>f</sub> = 6ns	24	30	36	
Maximum Output Rise and Fall Time (Figure 1,2)	t <sub>TLH</sub> , t <sub>THL</sub>	5V ±10%	C <sub>L</sub> = 50pF, t <sub>r</sub> = t <sub>f</sub> = 6ns	15	19	22	ns
Maximum Input Capacitance	C <sub>IN</sub>	-	-	10	10	10	pF
Power Dissipation Capacitance Per Gate <sup>7</sup>	C <sub>PD</sub>	-	T <sub>J</sub> = 25°C, V <sub>CC</sub> = 5.0V	TYPICAL			pF
				36			

6. Not production tested in die form, characterized by chip design and tested in package.

7. Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>.





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## Switching Waveform

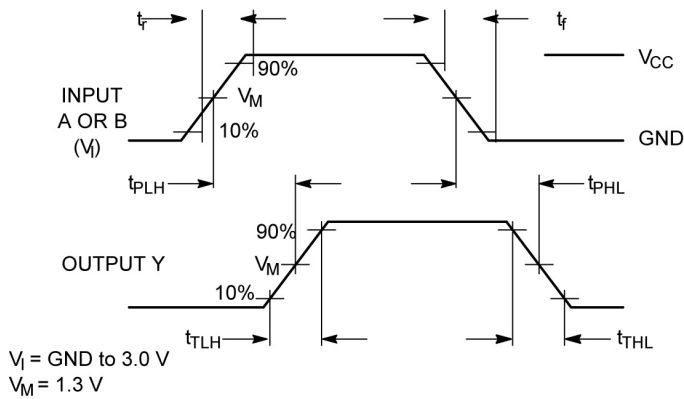
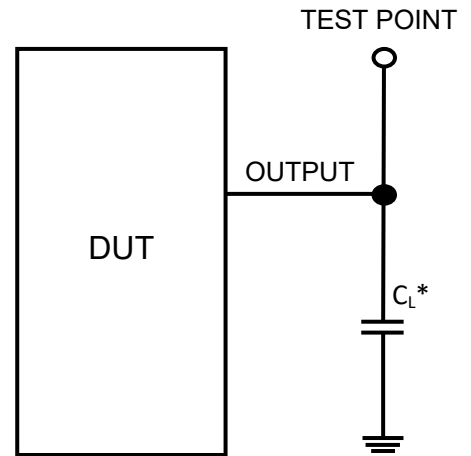


Figure 1 – Propagation Delay & Output Transition Time

## Test Circuit



\* Includes all probe and jig capacitance

Figure 2

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